

CONTACT DATA

Accepts 0.20mm - 0.33mm Diameter pins

3-finger

37/25 gram, Initial insertion force (with 0.254mm/0.203mm dia. pin)

30/22 gram, normal force (with 0.254mm/0.203mm dia. pin)

20/17 gram, extraction force (with 0.254mm0.203mm dia. pin)

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Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] FR4/G10 or equivalent high temp material. (RoHS)

2

Pins: material- Brass Alloy 360 1/2 hard; finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).

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Contacts: Beryllium Copper Alloy172, HT; Finish-0.25µm [10µ"] Au over 1.27µm [50µ"] Ni (min.).

4

Solder Balls (See table above)

Description: Giga-snaP BGA SMT Foot

400 position (1.27mm pitch) gold plated female receptacle pins to SMT solder balls (BGA type). Pin asignment 1:1.

Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.18mm [±0.007"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SF-BGA400F-B-32(F) Drawing	Status: Released	Scale: 4:1		Rev: B
© 2005 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: S.Natarajan		Date:5/18/05	
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